

IFW

00862.023490

PATENT APPLICATION



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: )  
: Examiner: David S. Blum  
KAZUTAKA YANAGITA ET AL. )  
: Group Art Unit: 2813  
Application No.: 10/787,195 )  
: Filed: February 27, 2004 )  
: For: BONDING SYSTEM AND )  
SEMICONDUCTOR )  
SUBSTRATE )  
MANUFACTURING METHOD : October 31, 2005

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE TO RESTRICTION REQUIREMENT

Sir:

(a) Introductory Comments

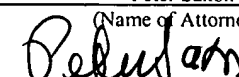
In response to the Office Action dated September 30, 2005, kindly amend  
the subject application as follows:

I hereby certify that this correspondence is being deposited with the  
United States Postal Service as first-class mail in an envelope addressed  
to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-  
1450 on

October 31, 2005  
(Date of Deposit)

Peter Saxon

(Name of Attorney for Applicant)

  
Signature

October 31, 2005

Date of Signature